

PRODUCTION DATA SHEET

DESCRIPTION

The LX7202 is an integrated identifies appropriate data line for full speed or appliances. low speed operation.

The 47 pF capacitor completes the Universal Serial Bus (USB) line high frequency filter and controls the termination device with an EMI filter edge rate of the USB signals. The and ESD protection diodes. This LX7202 protects both D+ and D- data device offers a cost effective and lines and the voltage bus from ESD. The compact solution for one USB TVS protection diodes exceed the upstream port. The USB specification requirements of IEC61000-4-2, level 4, requires line termination resistors on 15kV (air discharge) and 8kV (contact both the D+ and D- lines. These discharge). The integrated configuration resistors ensure signal integrity by of the LX7202 minimizes board space matching the cable impedance to that and allows for ideal placement near the of the differential driver. The 1.5 k Ω connector. The LX7202 is ideal for use the in USB hubs, peripherals and portable

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

I		PACKAGE ORDER INFO				
	T _J (°C)	SF	Plastic 6-Pin SOT23	Package Marking	Tape & Reel Quantity (Reel Size)	
ľ	-40 to 125	L	(7202-15ISF	2021	3K (7inches)	
ľ	-40 to 125	LX7202-22ISF		2022	Six (/iliches)	

Note: Append the letter "T" to the part number For Tape & Reel Ordering

KEY FEATURES

- Bi-directional EMI/RFI low-pass
- Line termination with integrated ESD protection
- Low TVS operating voltage (5.25V)
- Low leakage current
- Integrated single die construction
- Available with 15 or 22Ω Series Resistance
- Crosses from Semtech STF202

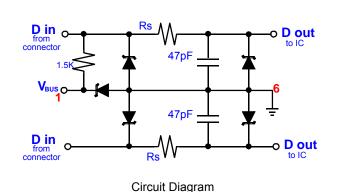
APPLICATIONS

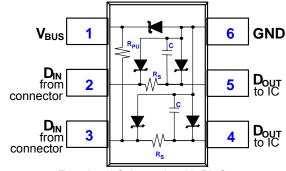
- USB 1.1 and USB 2.0 Full Speed Compliant
- Peripherals
- Computers and Printers
- Mobile phones
- Pagers and PDA's
- Digital Cameras

BENEFITS

- Filter response characterized up to 6 GHz
- <2dB insertion loss in the pass band
- >20dB attenuation in the 800-900 MHz range
- >12dB attenuation in the WLAN frequencies of 2.4GHz and 5.0-6.0 GHz

PRODUCT HIGHLIGHT





Functional Schematic with PinOut

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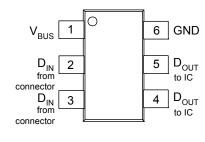
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ABSOLUTE MAXIMUM RATINGS

Steady State Power	100mW
ESD Air Discharge per IEC61000-4-2	16KV
ESD Contact Discharge per IEC61000-4-2	10KV
Lead Soldering Temperature (10 Seconds)	260°C
Operating Temperature	40°C to +125°C
Storage Temperature Range	55°C to +150°C

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

PACKAGE PIN OUT



SF PACKAGE

(Top View)

THERMAL DATA

SF	Plastic SOT-23	6-Pin
	1 1asuc 50 1-25	0-1 111

THERMAL RESISTANCE-JUNCTION TO CASE, θ_{JC}	62 °C/W
THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}	96 °C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.

The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

,	FUNCTIONAL PIN DESCRIPTION					
Name	Name Description					
VBUS	Bus Voltage					
DIN	Data In					
GND	Ground					
DOUT	Data Out					

ELECTRICAL CHARACTERISTICS

Unless otherwise specified, the following specifications apply over the operating ambient temperature -40°C $\leq T_A \leq$ +125°C except where otherwise noted.

Parameter	Symbol Test Conditions		LX7202-xx			Units
Farameter	Syllibol	rest conditions	Min	Тур	Max	Ullits
Stand-Off Voltage	VR _{WM}				5.25	V
Breakdown Voltage	V_{BR}	IR = 1mA	6			V
Leakage Current	I _R	VRWM = 5.25V, T = 25°C			1	μΑ
Series Resistance (-15)	Rs	Each Line	13.5	15	16.5	Ω
Series Resistance (-22)	R_{S}	Each Line	19.8	22	24.2	Ω
Temperature Coefficient of R _S	T _{COEFF}	Each Line		200		ppm
Pull Up Resistance	R_{PU}	Each Line	1.35	1.5	1.65	ΚΩ
Capacitor	С	Each Line		47		pF
Total Capacitance	Стот	Between I/O Pins and Ground, Each Device VR = 0V, f = 1MHz	54	60	66	pF



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APPLICATION CIRCUITS

Host or Hub (downstream) port Peripheral (upstream) port USB Transceiver Transceiver Transceiver Transceiver Transceiver

Figure 1 - Typical Application

APPLICATION INFORMATION

The LX7202 meets the requirements of the USB v1.1 and USB 2.0 Full Speed specification for device termination, EMI filtering and ESD protection. The RS resistor provides the proper signal termination; the 47pF capacitor controls the signal rise and fall slew; the TVS diodes protect the IC from ESD damage; and the total capacitance and resistance creates a low pass filter eliminating the high frequency energy from the circuit. The LX7202 can configure the upstream port for either Full-Speed or Low-Speed operation. The figures below show the proper connection in accordance with the USB specification.

FULL SPEED DEVICE

The USB 2.0 specification offers a 12 Mbps data transfer rate known as Full-Speed which requires a 1.5 k Ω pull-up resistor to be connected to the D+ line. Slew rate control is accomplished with 47pF attached to the transceiver before the $R_{\rm S}$.

- Voltage Supply (Vbus) is connected to Pin 1
- Ground is connected to Pin 6
- D+ from the connector is routed to Pin 3 (1.5 kΩ pull-up resistor) and Pin 4 to the D+ line of the USB Transceiver
- D- from the connector is routed to Pin 2 and Pin 5 to the D- line of the USB Transceiver

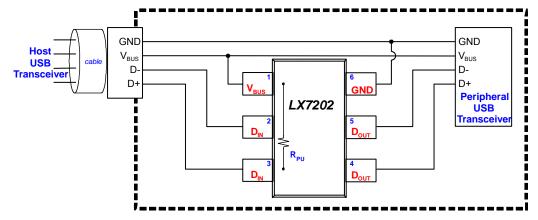


Figure 2 – Connection for Full Speed Operation



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APPLICATION INFORMATION (CONTINUED)

LOW SPEED DEVICE

The USB v1.1 specification offers a 1.5 Mbps data transfer rate known as Low-Speed which requires a 1.5 k Ω pull-up resistor to be connected to the D- line. Slew rate control is accomplished with 47pF attached to the transceiver before the $R_{\rm S}.$

- Voltage Supply (Vbus) is connected to Pin 1
- Ground is connected to Pin 6
- D+ from the connector is routed to Pin 2 and Pin 5 to the D+ line of the USB Transceiver
- D- from the connector is routed to Pin 3 (1.5 $\rm k\Omega$ pull-up resistor) and Pin 4 to the D- line of the USB Transceiver

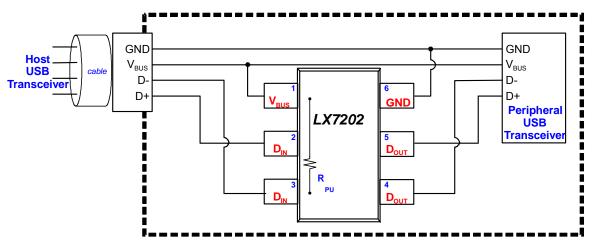


Figure 3 – Connection for Low Speed Operation

ELECTROMAGNETIC EMISSION AND SUSCEPTABILITY

FCC Part 15 sets limits for maximum allowable EM emission and susceptibility. There are two types of emissions. Conducted emissions with frequency of emission of 0.45 to 30 MHz and Radiated emissions with frequency of emission of 30 MHz to 40 GHz. All digital computing devices including the peripheral devices must comply. Examples of peripheral devices include terminals, printers, external floppy disk drives and other fixed adjustable data storage devices, video monitors, keyboards,

control cards, interface boards, external memory expansion cards and other input/output devices that may or may not contain digital circuitry. LX7202 is optimized to minimize the radiated EMI which is the primary concern in devices using USB. Refer to the typical filter response curve for the attenuation characteristics of LX7202 over the frequency range of 30KHz to 6GHz.



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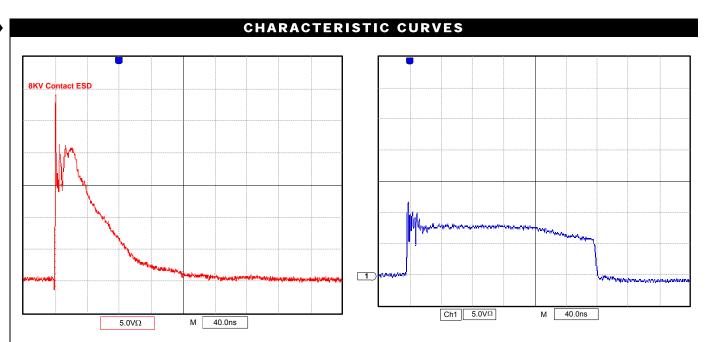


Figure 4 – 8KV ESD input pulse as per IEC61000-4-2. Vertical scale is equivalent to 5A/div.

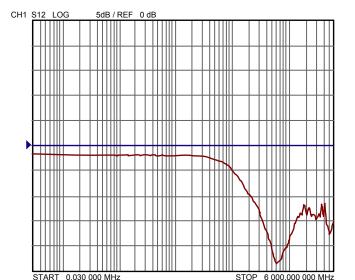
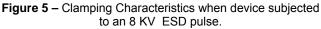


Figure 6 – Frequency response curve. Low insertion loss in the pass band and -20dB attenuation at 800-900 MHz. Better than -10dB attenuation at the WLAN frequencies of 2.4 and 5.0-6.0 GHz.



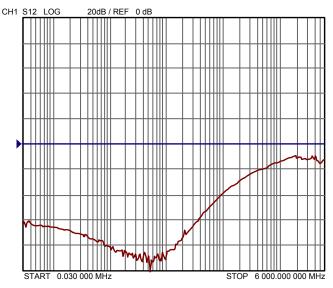


Figure 7 – Analog Crosstalk between the two datalines D-and D+

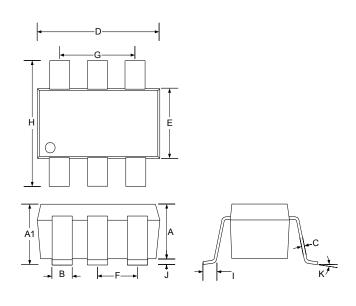


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PACKAGE DIMENSIONS

SR

6 Pin Plastic SOT-23

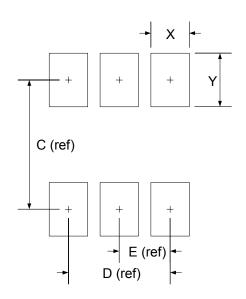


	MILLIM	IETERS	INCHES	
Dim	MIN	MAX	MIN	MAX
Α	0.90	1.30	0.035	0.051
A1	0.90	1.45	0.035	0.057
В	0.25	0.50	0.010	0.020
С	0.09	0.20	0.004	0.008
D	2.80	3.10	0.110	0.122
E	1.50	1.75	0.059	0.069
F	0.95	BSC	0.038 BSC	
G	1.90	BSC	0.075	BSC
Н	2.60	3.00	0.102	0.118
	0.35	0.55	0.014	0.022
J	0.00	0.15	0.000	0.006
K	10° MAX		10° MAX	

Note:

 Dimensions do not include mold flash or protrusions; these shall not exceed 0.155mm(.006") on any side. Lead dimension shall not include solder coverage.

Recommended Footprint



		MILLIN	IETERS	INCHES		
D	im	MIN	MAX	MIN	MAX	
	С	-	2.40	-	0.094	
	D	-	1.90	-	0.074	
	E	-	0.95	-	0.037	
	X	-	0.70	-	0.028	
,	Υ	-	1.00	_	0.039	



LX7202-xx

EMI Filter & ESD Protection for Up Stream USB Ports

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NOTES

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